

## Statement of Compliance

#### **Requested Part**

| 08 June 2023   | 1-28283                    | 38-2   | (Part 1 of 1) |  |  |
|--|----------------------------|--|---------------|--|--|
|  | TE Internal Number:        | 1-282838-2   |               |  |  |
|  | Product Description:       | TERMI-BLOK PCB MOUNT 90 11F                            | )             |  |  |
|  | Part Status:               | Active   |               |  |  |
|  | Mil-Spec Certified:        | No   |               |  |  |
| EUF  | RoHS Directive 2011/65/EU: | Compliant with Exemptions<br>6(c) - Pb-Alloy in Copper |               |  |  |
| This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU. |                            |  |               |  |  |
|  | EU ELV Directive:          | Compliant with Exemptions                              |               |  |  |

| EU ELV Directive:                                 | Compliant with Exemptions   |
|---|---|
| 2000/53/EC  | 3 - Lead in copper alloy containing up to 4% lead by weight.  |
| China RoHS 2 Directive:<br>MIIT Order No 32, 2016 | Restricted Materials Above Threshold  |
| EU REACH Regulation:                              | Current ECHA Candidate List: JAN 2023 (233)   |
| (EC) No. 1907/2006                                | Candidate List Declared Against: <b>JAN 2023 (233)</b><br>SVHC > Threshold:<br>Pb (.8% in Component Part)   |
|   | Article Safe Usage Statements:<br>Do not eat, drink or smoke when using this product. Wash thoroughly after<br>handling. Recycle if possible and dispose of the article by following all applicable<br>governmental regulations relevant to your geographic location. |
| Halogen Content:                                  | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free   |
| Solder Process Capability Code:                   | Wave solder capable to 265°C  |

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

08 June 2023

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### 中国电子电气产品中有害物质的名称及含量

#### China EEP Hazardous Substance Information

| 部件名称   | 有害物质                        |   |   |                        |                |                |  |
|--|-----------------------------|---|---|------------------------|----------------|----------------|--|
| (Component Name)                                       | Hazardous Substance         |   |   |                        |                |                |  |
| 1-282838-2   | 铅                           | 汞   | 镉   | 六价铬                    | 多溴联苯           | 多溴二苯醚          |  |
|  | (Pb)                        | (Hg)  | (Cd)  | (Cr6)                  | (PBB)          | (PBDE)         |  |
| 连接器系统  | x                           | 0   | 0   | 0                      | 0              | 0              |  |
| (Connector Systems)                                    |                             |   |   |                        |                |                |  |
| Indicates that the                                     |                             |   |   | n all homogen          | eous materials | of the part is |  |
| below the relevar                                      | nt threshold of th          | ie GB/1 26572                                 | standard.   |                        |                |                |  |
| X: 表示该有害物质3  | 至少在该部件的某                    | 其一均质材料中                                       | 的含量超出GB   |                        |                |                |  |
|  | 至少在该部件的事<br>concentration c | 其一均质材料中<br>of the hazardou                    | 的含量超出GB<br>us substance ir                              | n at least one         |                |                |  |
| X: 表示该有害物质3<br>Indicates that the<br>part is above the | 至少在该部件的事<br>concentration c | 其一均质材料中<br>of the hazardou<br>old of the GB/T | 的含量超出GB<br>us substance ir<br><sup>-</sup> 26572 standa | n at least one<br>ird. | homogeneous    |                |  |

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